

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
PEICONG QI	09/04/2020
HAOMING SONG	09/07/2020
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16978635
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SIGNATURE:	/Alexander Slafkosky/
DATE SIGNED:	09/11/2020
Total Attachments: 2	
source=2020-09-09 Executed Assignment 00583901#page1.tif	
source=2020-09-09 Executed Assignment 00583901#page2.tif	

ASSIGNMENT

WHEREAS I, a below named inventor, have made a new and useful invention described in a patent application entitled:

BLOWING MEANS UNIT AND HOT FOIL STAMPING AND DIE-CUTTING DEVICE

for which I executed an application for United States Letters Patent filed in the U.S. Patent and Trademark Office ("USPTO") herewith, and/or being identified in the USPTO by Application No. 16/978,635, filed Sep. 4, 2020, and

WHEREAS, Bobst (Shanghai) Ltd, a company of Shanghai, China whose address is 330 Songdong Road, Songjiang Industrial zone, 201613 Shanghai, China, hereinafter referred to as Assignee, is desirous of securing and memorializing its entire right, title, and interest in and to this invention in all countries throughout the world, and in and to any provisional or nonprovisional applications for United States Letters Patent on this invention and any Letters Patent to be issued upon this application, its related application(s) including Chinese Application No. 201810179095.6, filed on March 5, 2018, and International Application No. PCT/IB2019/051714, filed on March 4, 2019 (hereinafter "Related Application(s)"), or any application claiming priority to this application or the Related Application(s);

NOW THEREFORE, be it known that, for good and valuable consideration, the receipt of which from Assignee is hereby acknowledged, I have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my entire right, title, and interest in and to this invention, all nonprovisional applications, divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of the above application(s), including the Related Application(s), and/or Letters Patent, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I HEREBY covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment;

AND, I HEREBY authorize the Assignee (or its designee) to apply for patent (or similar legal protection) in its own name if desired, in any and all countries;

AND, I HEREBY authorize the Assignee to insert in this Assignment the filing date and application number of said application when known;

AND, I HEREBY further covenant and agree that I will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all nonprovisional, divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I have hereunto set my hands.

Name: Peicong Qi
Address: No. 149# fifth village Caoyang
Putuo District, Shanghai, China

Signed: 齐培聪

Date: 2020-9-4

Name: Haoming SONG
Address: #620 Weiye Road 10-1301
Minghang District, 201100
Shanghai, China

Signed: 宋浩明

Date: 2020-9-7